

# First Wall Quality Mockup Testing

**ITER FWQM 5 meeting  
Sept 26-29, 2007  
Caderache, Fr**

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# Outline

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- **Testing conditions at SNL**
  - Test article
  - Heat flux conditions
- **What is the failure criteria?**



# **First wall-the initial heat and radiation barrier for the vacuum chamber**

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- **Steady state heat load**
  - 10,000 “shots” at 0.25-0.50 MW/m<sup>2</sup> of surface heat
  - 20,000 shots at below 0.25 MW/m<sup>2</sup> of surface heat
  - Approx 6 MW/m<sup>3</sup> of nuclear heating from the neutrons (exact estimates vary with nuclear analysis)
- **MARFE**
  - 1,000 shots between 0.5 and 1.4 MW/m<sup>2</sup> <10s long
- **VDE**
  - 10 shots with <60 MJ/m<sup>2</sup>, <0.2 s long

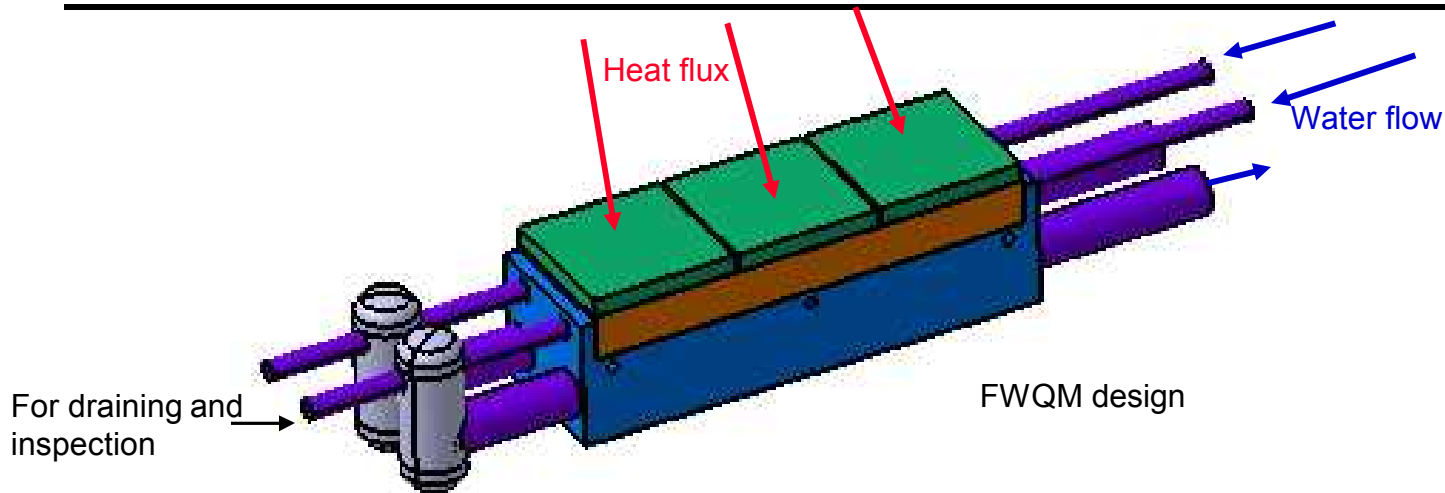
# Mockups will be tested in US or EU

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- The US facility is the Plasma Materials Test Facility at Sandia National Laboratories
- We plan to use EB1200 which has an electron beam that can be focused and moved across the beryllium tiles

# Test Article

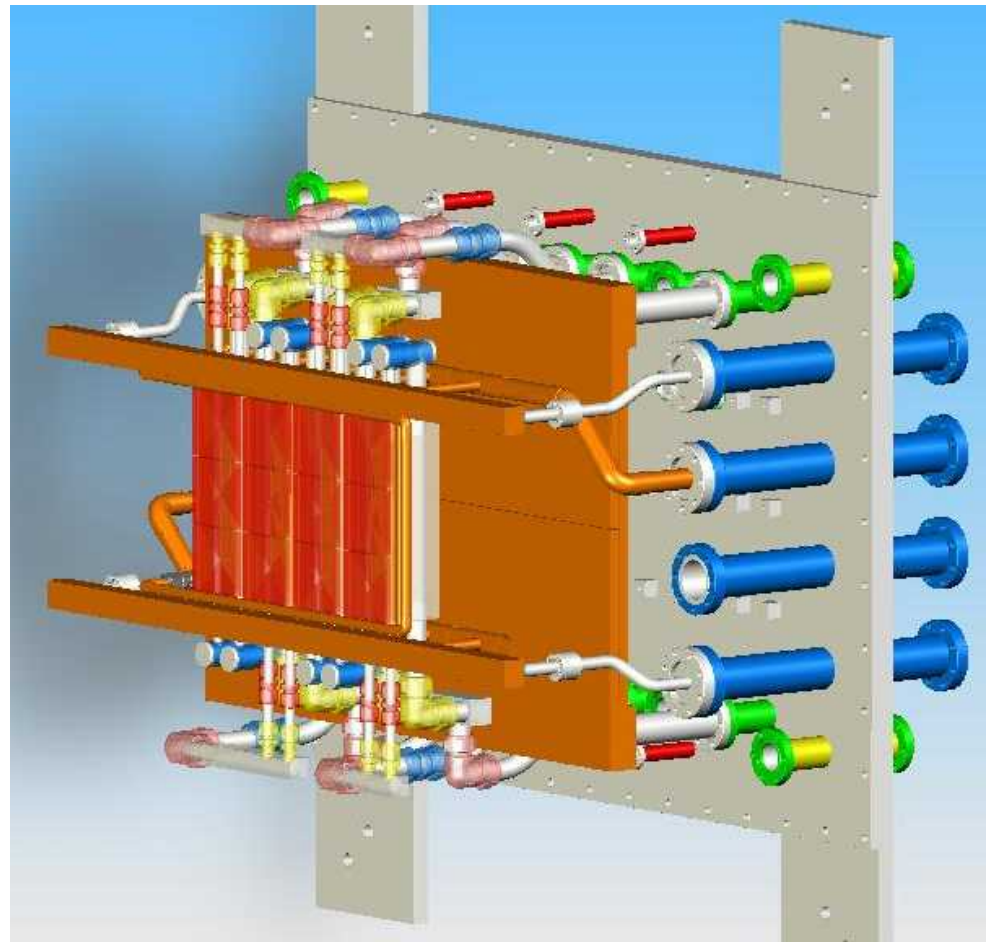


- The ITER international organization (IO) has proposed a mockup to be used for qualification of the joining process
- Mockup uses typical (80 x 80 x 10 mm) tile sizes, copper alloy thicknesses from the inboard vacuum vessel
- But does not include the curved tubes that are in the real first wall.
- Parties are required to make 3 mockups and have 2 that pass fatigue tests
- Test conditions were proposed by IO which includes slowing water velocity to make up for lack of neutron heating

# Test conditions at SNL

- We plan to test four FWQM at one time using 2 e-guns
- 2 IR cameras will determine surface temperature
- Coolant velocity slowed to simulate neutron heating

Heat flux on tiles	0.7 MW/m <sup>2</sup>
Coolant velocity in tubes	1 m/s
Coolant Temperature	100 C
Number of cycles	12,000
Absorbed power/cycle	13.4 kW
Temperature rise (coolant)	~20C
Cycle time (on and off)	96 s





# Testing Time Table

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<b>Facility ready</b>	<b>November 2007</b>
<b>Time to test 4 mockups</b>	<b>3.5 months</b>
<b>First set of mockups (Nov)</b>	<b>EU, JA, US, and ?</b>
<b>Second set of mockups (Apr)</b>	<b>CN, KO, ? and ?</b>



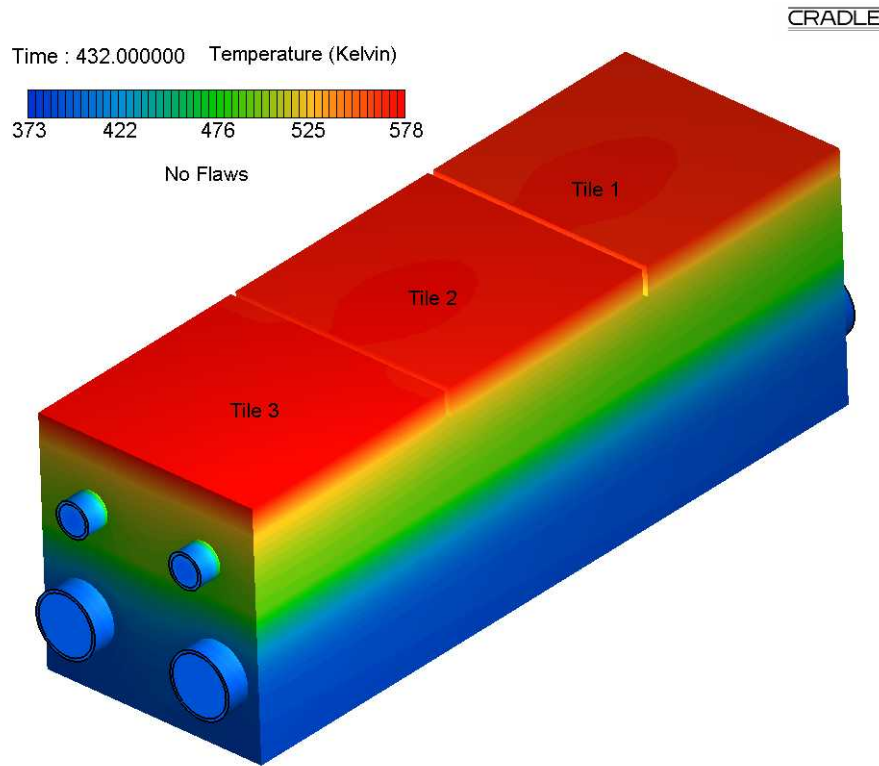
# Diagnostics

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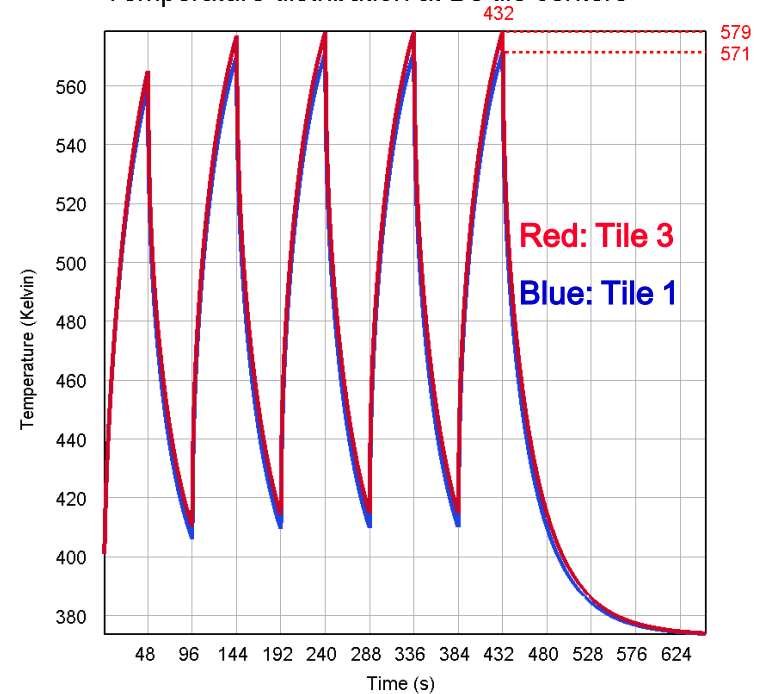
- **3 TC's per mockup installed 2 mm above Be/Cu interface-spring loaded and provided by USPT**
- **Flow meters on total flow into each mockup**
- **RTD on water inlet and outlet for each mockup at the door position for calorimetry**
- **2 IR cameras to measure surface temperature, 1 camera for 2 mockups**
- **Pressure drop outside of door**
- **2 IR pyrometers-backup for interlocks**
- **Video recording of visible image**



# Expected temperatures for test conditions (No flaws in Be-Cu joint)



Temperature distribution at Be tile centers



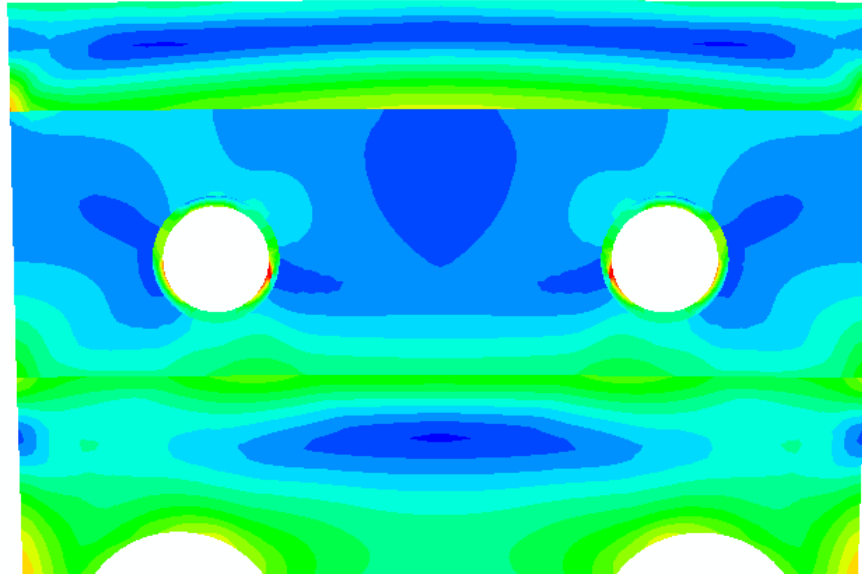
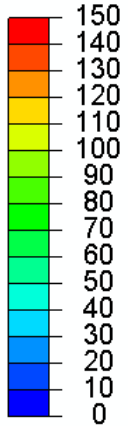
Tiles subject to 5 heating cycles of 48 seconds each. (48 sec on 48 sec off)

FWQM temperature distribution at 432 seconds into heating cycle

Max Temperature/ Be-Cu interface	~250 C
Min Temperature/ Be-Cu interface	~235 C
Max Temperature/ Be	~300 C

# How will a mockup fail?

S, Tresca  
(Avg: 75%)



Be-Cu Interface

2D generalized plane  
strain calculation using  
ABAQUS

- We expect failures to start at the edge of the tile, where stresses are higher
- If the Be tile starts to peel up from Cu, we expect that the surface temperature will increase because the tile is no longer well connected to the heat sink



## **Failure criteria**

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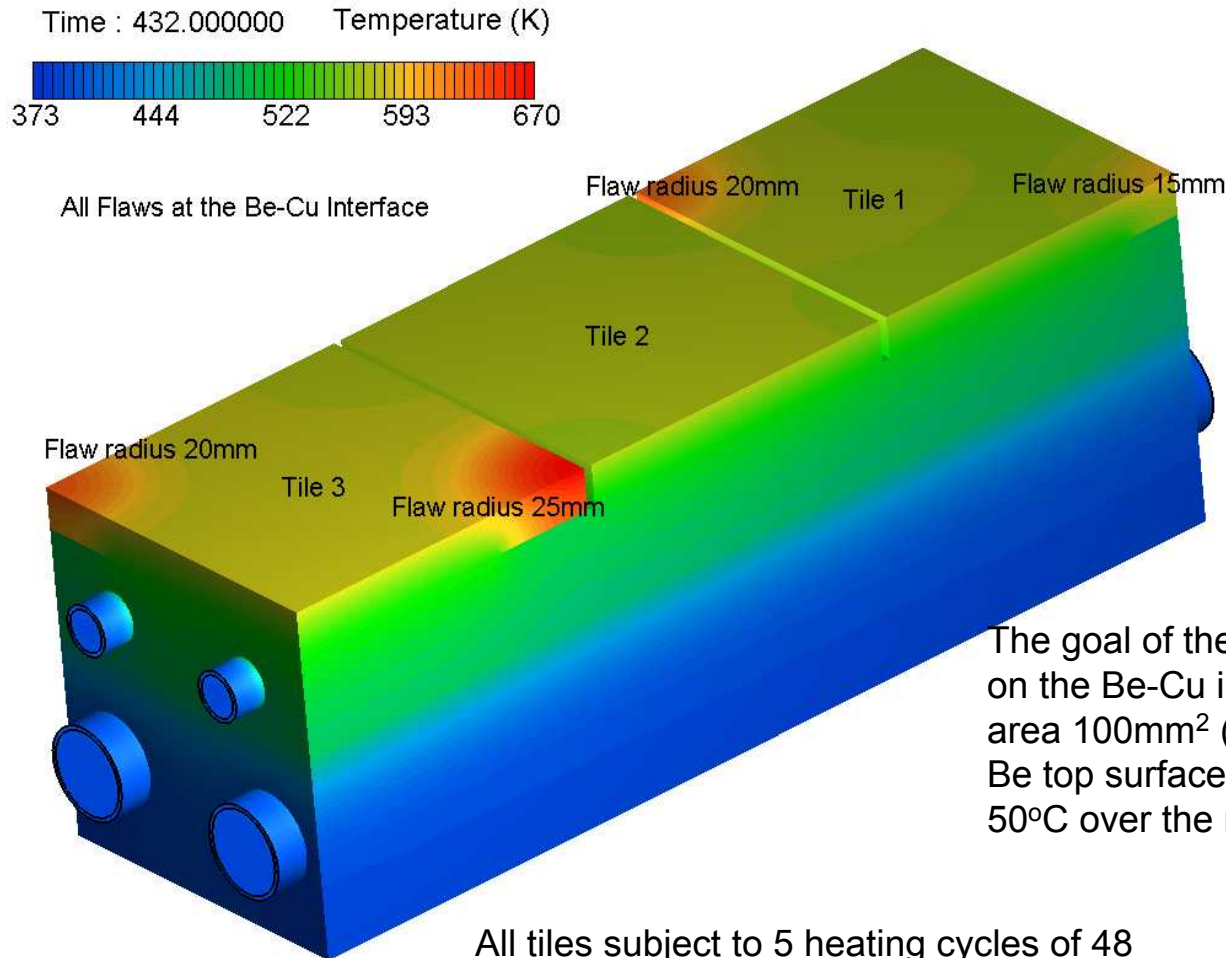
**If at any time, the average temperature on any 100 mm<sup>2</sup> local area minus the average temperature on the whole Be top surface is greater than 50 °C, the mock-up has failed**

- This will be determined by IR camera**
- The IR camera has 220 x 400 pixels, and each mockup has a top surface of 244 x 80 mm, so 100 mm<sup>2</sup> is easily resolved**
- Total temperature range of surface is expected to be 200 °C without flaws, so a 50 °C excursion is large**

# Be-Cu Joint Flaw Size Study

A series of four quarter circular regions of varying sizes were assigned zero interface conductance at the Be-Cu interface to simulate a flaw in the joint

CRADLE



Flaw sizes introduced at Be-Cu:

Tile 1: radius 15mm and 20mm

Tile 2: no flaw

Tile 3: radius 20mm and 25mm

The goal of the study was to ascertain the flaw size on the Be-Cu interface that causes a hot spot of area  $100\text{mm}^2$  (quarter circle radius  $\sim 11\text{mm}$ ) on the Be top surface, with a temperature in excess of  $50^\circ\text{C}$  over the rest of the surface

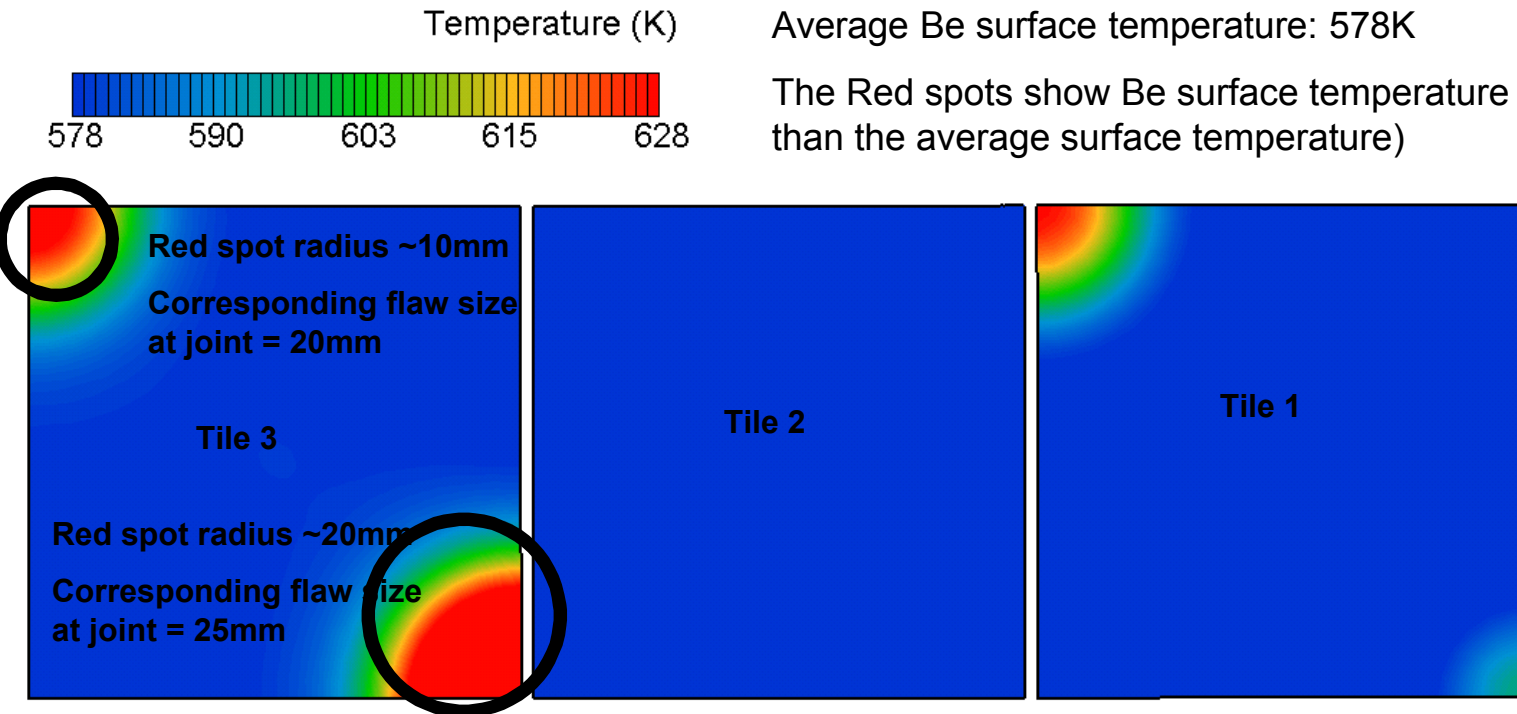
All tiles subject to 5 heating cycles of 48 seconds each. (48 sec on 48 sec off)

# Be-Cu Joint Flaw Size Study

Be-Top surface temperature distribution under Be-Cu joint flaws  
at the end of 5<sup>th</sup> heating cycle CRADLE

Average Be surface temperature: 578K

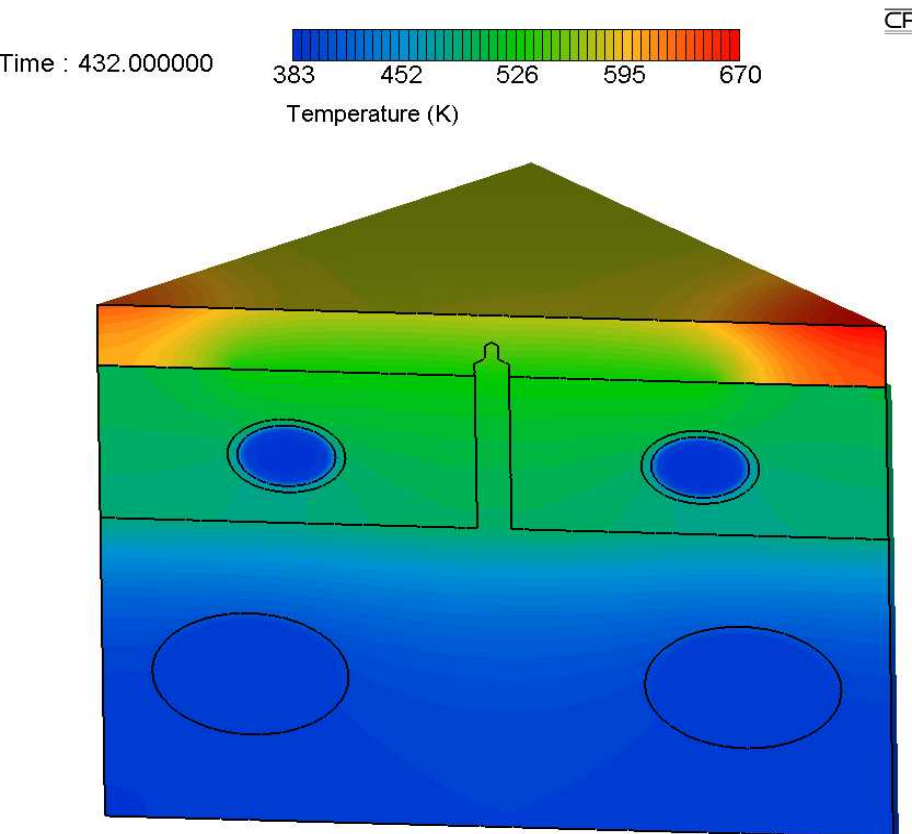
The Red spots show Be surface temperature of 628K (50° more than the average surface temperature)



A quarter circle hot spot radius of 10mm on Be top surface equals an area of ~80mm<sup>2</sup>

Hence a flaw size (for quarter circle flaws) of over 20mm and under 25mm will cause a hot spot on the Be top surface with a temperature in excess of 50°C from the rest of the surface.

# Effects of flaws on TC temperatures



Tile 3 cut diagonally

- Heating due to flaws is localized
- We cannot detect a flaw in the Be-Cu joint based on TC temperatures

TC temperatures

Tile 1 (No flaws)	257.0 °C
Tile 1 (With flaws)	257.5 °C



# Summary

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- **Testing will be performed at PMTF (Sandia National Laboratories) on an electron beam facility**
- **The failure criteria for the US facility is dependent on the surface temperature; a 100 mm<sup>2</sup> area that is 50 °C above rest of tiles**
- **Predicted flaw size calculated to generate the failure criteria is a 20-25 mm radius quarter circle**
- **We cannot detect a flaw in the Be-Cu joint based on TC temperatures**



# Acknowledgements

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- **ITER International Organization in Caderache, Kimihiro Ioki and Xiaoyu Wang for technical specifications and determination of the mockup test conditions**
- **Sandia National Laboratories, James Bullock 3D CAD designs**